In the Claims

CLAIMS

Claims 1-30 (Canceled).

- 31. (New) An engagement probe comprising semiconductor bulk substrate material, the probe having a grouping of a plurality of projecting apexes positioned in sufficient proximity to one another to collectively removably engage a plurality of different single conductive pads on a plurality of different semiconductor substrates to test circuitry coupled with the single conductive pads.
- 32. (New) The engagement probe of claim 31 wherein the projecting apexes are arranged in an interconnecting structure lacking lateral terminal ends.
- 33. (New) The engagement probe of claim 31 wherein the projecting apexes are in the shape of multiple knife-edge lines.
- 34. (New) The engagement probe of claim 31 wherein the projecting apexes are in the shape of multiple knife-edge lines, the multiple knife-edge lines being positioned to form at least one polygon.

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- 35. (New) The engagement probe of claim 31 wherein the projecting apexes comprise outermost portions which constitute a first electrically conductive material, and wherein the respective different single conductive pads for which the probe is adapted have outermost portions constituting a second electrically conductive material; the first and second electrically conductive materials being different.
- 36. (New) The engagement probe of claim 31 wherein the projecting apexes project from a common plane, the projecting apexes having respective tips and bases, the bases of adjacent projecting apexes being spaced from one another to define a penetration stop plane therebetween.
- 37. (New) The engagement probe of claim 31 wherein the projecting apexes have a selected projecting distance, the projecting distance being about one-half the thickness of the respective different single conductive pads which the apparatus is adapted to engage.
- 38. (New) The engagement probe of claim 31 wherein the projecting apexes are in the shape of multiple knife-edge lines, the multiple knife-edge lines being positioned to form the interconnecting structure comprising at least two polygons one of which is received entirely within the other.